74HC1G14; 74HCT1G14

Inverting Schmitt trigger Rev. 6 — 27 December 2012

Product data sheet

1. **General description**

74HC1G14 and 74HCT1G14 are high-speed Si-gate CMOS devices. They provide an inverting buffer function with Schmitt trigger action. These devices are capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

The HC device has CMOS input switching levels and supply voltage range 2 V to 6 V.

The HCT device has TTL input switching levels and supply voltage range 4.5 V to 5.5 V.

The standard output currents are half of those of the 74HC14 and 74HCT14.

Features and benefits 2.

- Symmetrical output impedance
- High noise immunity
- Low power dissipation
- Balanced propagation delays
- SOT353-1 and SOT753 package options
- Specified from -40 °C to +125 °C

Applications 3.

- Wave and pulse shapers
- Astable multivibrators
- Monostable multivibrators

Ordering information

Table 1. **Ordering information**

Type number	Package	Package									
	Temperature range	Name	Description	Version							
74HC1G14GW	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package;	SOT353-1							
74HCT1G14GW			5 leads; body width 1.25 mm								
74HC1G14GV	–40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753							
74HCT1G14GV											



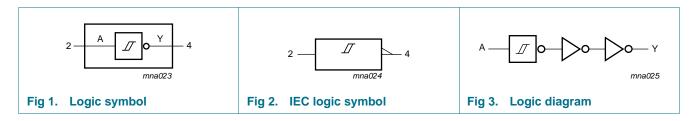
5. Marking

Table 2. Marking codes

Type number	Marking code ^[1]
74HC1G14GW	HF
74HCT1G14GW	TF
74HC1G14GV	H14
74HCT1G14GV	T14

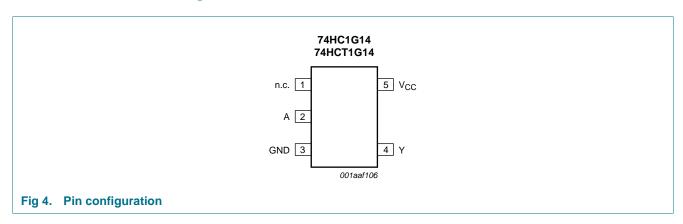
^[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

6. Functional diagram



7. Pinning information

7.1 Pinning



7.2 Pin description

Table 3. Pin description

	•	
Symbol	Pin	Description
n.c.	1	not connected
A	2	data input
GND	3	ground (0 V)
Υ	4	data output
V _{CC}	5	supply voltage

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8. Functional description

Table 4. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level$

Input	Output
A	Υ
L	Н
H	L

9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V). [1]

		, ,			,
Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+7.0	V
I _{IK}	input clamping current	$V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I _{OK}	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I _O	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±12.5	mA
I _{CC}	supply current		-	25	mA
I _{GND}	ground current		-25	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[2] _	200	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

10. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	7	4HC1G1	4	74	Unit		
			Min	Тур	Max	Min	Тур	Max	
V_{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
V _I	input voltage		0	-	V_{CC}	0	-	V_{CC}	V
V _O	output voltage		0	-	V_{CC}	0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C

^[2] Above 55 °C, the value of P_{tot} derates linearly with 2.5 mW/K.

11. Static characteristics

Table 7. Static characteristics

Voltages are referenced to GND (ground = 0 V). All typical values are measured at T_{amb} = 25 °C.

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	-40 °C 1	to +125 °C	Unit	
			Min	Тур	Max	Min	Max		
For type 7	74HC1G14								
V _{OH}	HIGH-level output	$V_I = V_{T+}$ or V_{T-}							
	voltage	$I_O = -20 \mu A; V_{CC} = 2.0 V$	1.9	2.0	-	1.9	-	V	
		$I_O = -20 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	4.4	-	V	
		$I_O = -20 \mu A; V_{CC} = 6.0 V$	5.9	6.0	-	5.9	-	V	
		$I_{O} = -2.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	4.13	4.32	-	3.7	-	V	
		$I_{O} = -2.6 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.63	5.81	-	5.2	-	V	
V _{OL}	LOW-level output	$V_I = V_{T+}$ or V_{T-}							
	voltage	$I_O = 20 \mu A; V_{CC} = 2.0 V$	-	0	0.1	-	0.1	V	
		$I_O = 20 \mu A$; $V_{CC} = 4.5 V$	-	0	0.1	-	0.1	V	
		$I_O = 20 \mu A; V_{CC} = 6.0 \text{ V}$	-	0	0.1	-	0.1	V	
		$I_O = 2.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.33	-	0.4	V	
		$I_O = 2.6 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.33	-	0.4	V	
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	1.0	-	1.0	μΑ	
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	10	-	20	μΑ	
Cı	input capacitance		-	1.5	-	-	-	pF	
V_{T+}	positive-going	see Figure 7 and Figure 8							
	threshold voltage	V _{CC} = 2.0 V	0.7	1.09	1.5	0.7	1.5	V	
		V _{CC} = 4.5 V	1.7	2.36	3.15	1.7	3.15	V	
		V _{CC} = 6.0 V	2.1	3.12	4.2	2.1	4.2	V	
V_{T-}	negative-going	see Figure 7 and Figure 8							
	threshold voltage	V _{CC} = 2.0 V	0.3	0.60	0.9	0.3	0.9	V	
		V _{CC} = 4.5 V	0.9	1.53	2.0	0.9	2.0	V	
		V _{CC} = 6.0 V	1.2	2.08	2.6	1.2	2.6	V	
V _H	hysteresis voltage	see Figure 7 and Figure 8							
		V _{CC} = 2.0 V	0.2	0.48	1.0	0.2	1.0	V	
		V _{CC} = 4.5 V	0.4	0.83	1.4	0.4	1.4	V	
		$V_{CC} = 6.0 \text{ V}$	0.6	1.04	1.6	0.6	1.6	V	
For type 7	74HCT1G14								
V _{OH}	HIGH-level output	$V_I = V_{T+}$ or V_{T-}							
	voltage	$I_{O} = -20 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	4.4	-	V	
		$I_{O} = -2.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	4.13	4.32	-	3.7	-	V	
V _{OL}	LOW-level output	$V_I = V_{T+}$ or V_{T-}							
	voltage	$I_O = 20 \mu A$; $V_{CC} = 4.5 V$	-	0	0.1	-	0.1	V	
		$I_O = 2.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.33	-	0.4	V	
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	1.0	-	1.0	μΑ	

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 Table 7.
 Static characteristics ...continued

Voltages are referenced to GND (ground = 0 V). All typical values are measured at T_{amb} = 25 °C.

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	-40 °C t	Unit	
			Min	Тур	Max	Min	Max	
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	10	-	20	μΑ
ΔI_{CC}	additional supply current	per input; V_{CC} = 4.5 V to 5.5 V; $V_I = V_{CC} - 2.1$ V; I_O = 0 A	-	-	500	-	850	μΑ
Cı	input capacitance		-	1.5	-	-	-	pF
	positive-going	see Figure 7 and Figure 8						
	threshold voltage	$V_{CC} = 4.5 \text{ V}$	1.2	1.55	1.9	1.2	1.9	V
		$V_{CC} = 5.5 \text{ V}$	1.4	1.80	2.1	1.4	2.1	V
V_{T-}	negative-going	see Figure 7 and Figure 8						
	threshold voltage	$V_{CC} = 4.5 \text{ V}$	0.5	0.76	1.2	0.5	1.2	V
		$V_{CC} = 5.5 \text{ V}$	0.6	0.90	1.4	0.6	1.4	V
V_{H}	hysteresis voltage	see Figure 7 and Figure 8						
		$V_{CC} = 4.5 \text{ V}$	0.4	0.80	-	0.4	-	V
		$V_{CC} = 5.5 \text{ V}$	0.4	0.90	-	0.4	-	V

12. Dynamic characteristics

Table 8. Dynamic characteristics

GND = 0 V; $t_r = t_f \le 6.0$ ns; All typical values are measured at $T_{amb} = 25$ °C. For test circuit see Figure 6

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C t	Unit	
				Min	Тур	Max	Min	Max	
For type	74HC1G14								
t _{pd}	propagation delay	A to Y; see Figure 5	[1]						
		$V_{CC} = 2.0 \text{ V}; C_L = 50 \text{ pF}$		-	25	155	-	190	ns
		$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$		-	12	31	-	38	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$		-	10	-	-	-	ns
		$V_{CC} = 6.0 \text{ V}; C_L = 50 \text{ pF}$		-	11	26	-	32	ns
C_{PD}	power dissipation capacitance	$V_I = GND \text{ to } V_{CC}$	[2]	-	20	-	-	-	pF
For type	74HCT1G14								
t _{pd}	propagation delay	A to Y; see Figure 5	<u>[1]</u>						
		$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$		-	17	43	-	51	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$		-	15	-	-	-	ns
C_{PD}	power dissipation capacitance	$V_I = GND \text{ to } V_{CC} - 1.5 \text{ V}$	[2]	-	22	-	-	-	pF

^[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i$ + \sum (C_L \times $V_{CC}{}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

 C_L = output load capacitance in pF; V_{CC} = supply voltage in Volts

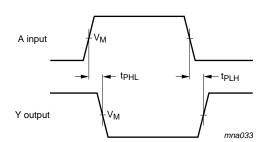
 $\sum \left(C_L \times V_{CC}{}^2 \times f_o \right)$ = sum of outputs

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^[2] C_{PD} is used to determine the dynamic power dissipation P_D (μW).

13. Waveforms

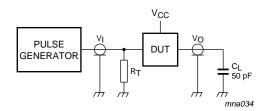


Measurement points are given in Table 9.

Fig 5. The input (A) to output (Y) propagation delays

Table 9. Measurement points

Type number	Input	nput			
	V _I	V _M	V _M		
74HC1G14	GND to V _{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$		
74HCT1G14	GND to 3.0 V	1.5 V	0.5 × V _{CC}		



Test data is given in Table 8. Definitions for test circuit:

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

Fig 6. Load circuitry for switching times

14. Transfer characteristics waveforms

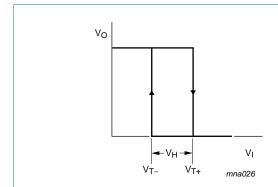


Fig 7. Transfer characteristic

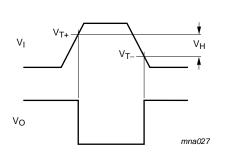


Fig 8. The definitions of V_{T+} , V_{T-} and V_H ; where V_{T+} and V_{T-} are between limits of 20 % and 70 %

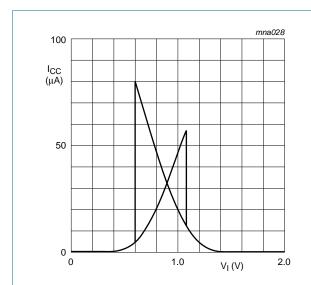


Fig 9. Typical 74HC1G14 transfer characteristics; V_{CC} = 2.0 V

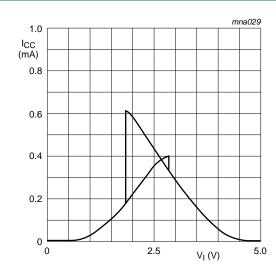


Fig 10. Typical 74HC1G14 transfer characteristics; V_{CC} = 4.5 V

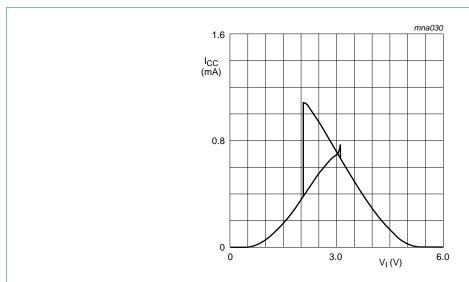


Fig 11. Typical 74HC1G14 transfer characteristics; V_{CC} = 6.0 V

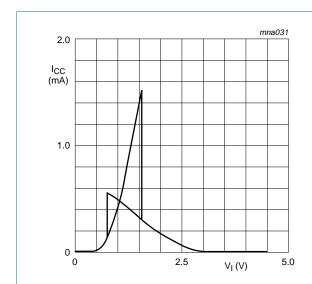


Fig 12. Typical 74HCT1G14 transfer characteristics; $V_{CC} = 4.5 \text{ V}$

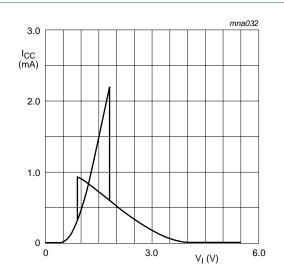


Fig 13. Typical 74HCT1G14 transfer characteristics; $V_{CC} = 5.5 \text{ V}$

15. Application information

The slow input rise and fall times cause additional power dissipation, this can be calculated using the following formula:

$$P_{add} = f_i \times (t_r \times \Delta I_{CC(AV)} + t_f \times \Delta I_{CC(AV)}) \times V_{CC}$$

Where:

 P_{add} = additional power dissipation (μW)

 $f_i = input frequency (MHz)$

 t_r = rise time (ns); 10 % to 90 %

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 t_f = fall time (ns); 90 % to 10 %

 $\Delta I_{CC(AV)}$ = average additional supply current (μA)

 $\Delta I_{CC(AV)}$ differs with positive or negative input transitions, as shown in <u>Figure 14</u> and <u>Figure 15</u>.

74HC1G14 and 74HCT1G14 used in relaxation oscillator circuit, see Figure 16.

Remark: All values given are typical unless otherwise specified.

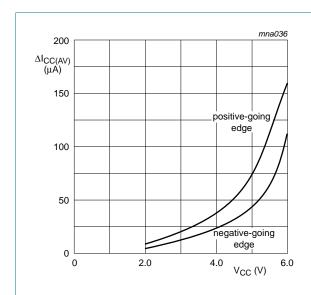


Fig 14. $\Delta I_{CC(AV)}$ for 74HC1G14 devices; linear change of V_I between 0.1 \times V_{CC} to 0.9 \times V_{CC}

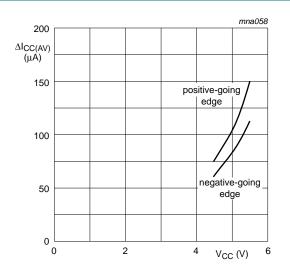
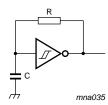


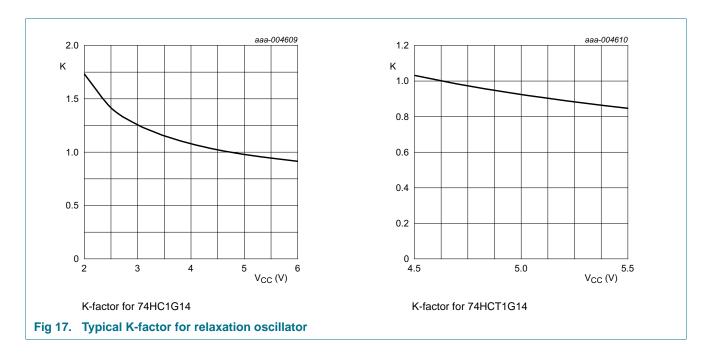
Fig 15. $\Delta I_{CC(AV)}$ for 74HCT1G14 devices; linear change of V_I between 0.1 \times V_{CC} to 0.9 \times V_{CC}



For 74HC1G14 and 74HCT1G14: $f = \frac{I}{T} \approx \frac{I}{K \times RC}$

For K-factor, see Figure 17

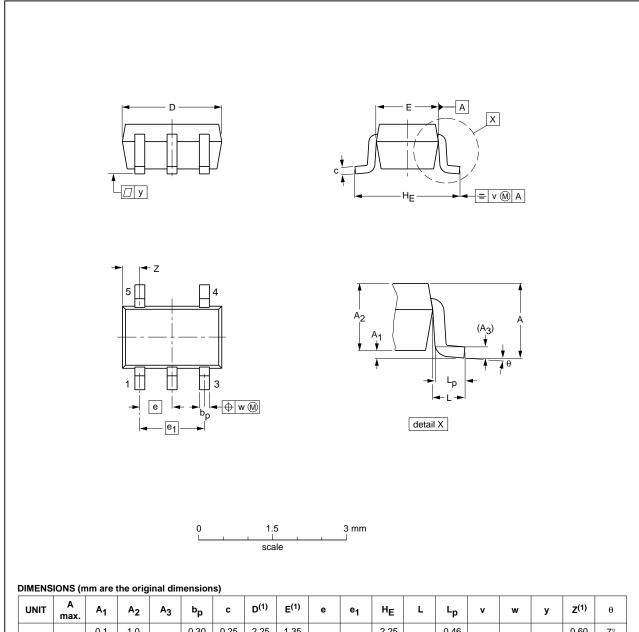
Fig 16. Relaxation oscillator using 74HC1G14 and 74HCT1G14



16. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	HE	L	Lp	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.1 0	1.0 0.8	0.15	0.30 0.15	0.25 0.08	2.25 1.85	1.35 1.15	0.65	1.3	2.25 2.0	0.425	0.46 0.21	0.3	0.1	0.1	0.60 0.15	7° 0°

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT353-1		MO-203	SC-88A			-00-09-01- 03-02-19	

Fig 18. Package outline SOT353-1 (TSSOP5)

74HC_HCT1G14

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Plastic surface-mounted package; 5 leads

SOT753

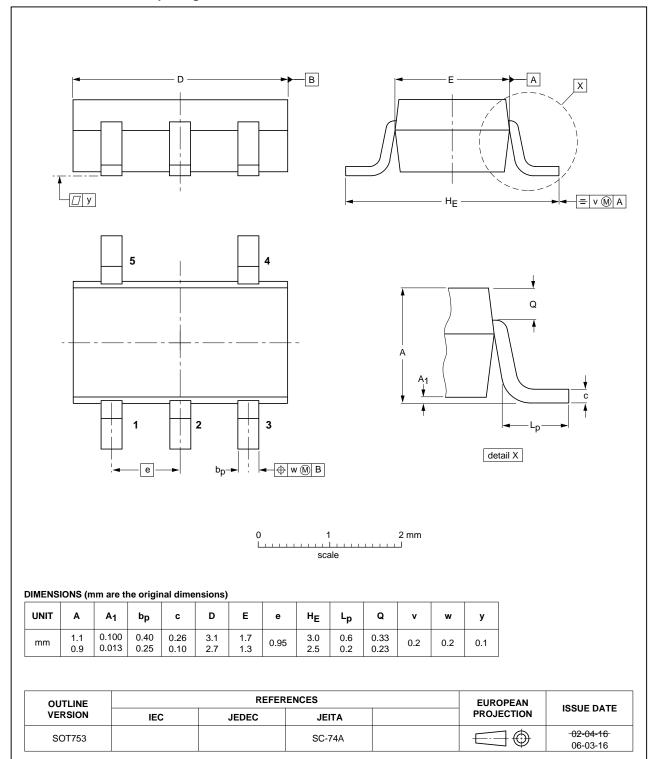


Fig 19. Package outline SOT753 (SC-74A)

17. Abbreviations

Table 10. Abbreviations

Acronym	Description
DUT	Device Under Test
TTL	Transistor-Transistor Logic

18. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT1G14 v.6	20121227	Product data sheet	-	74HC_HCT1G14 v.5
Modifications:	• <u>Table 3</u> : Pir	number Y output changed	from 5 to 4 (errata).	
74HC_HCT1G14 v.5	20120924	Product data sheet	-	74HC_HCT1G14 v.4
Modifications:	eations: • Figure 17 added (typical K-factor for relaxation oscillator).			
	 Legal page 	updated.		
74HC_HCT1G14 v.4	20070717	Product data sheet	-	74HC_HCT1G14 v.3
74HC_HCT1G14 v.3	20020515	Product specification	-	74HC_HCT1G14 v.2
74HC_HCT1G14 v.2	20010302	Product specification	-	74HC_HCT1G14 v.1
74HC_HCT1G14 v.1	19980805	Product specification	-	-

19. Legal information

19.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Inverting Schmitt trigger

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